L Number	Hits	Search Text	DB	Time stamp
2	4	(endpoint adj1 detect$) and electropolishing	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 10:33
3	578	(endpoint adj1 detect$) and polishing	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 10:33
4	16559	(endpoint adj1 detect$) and polishing or planarization	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 10:34
5	5494	((endpoint adj1 detect$) and polishing or planarization) and pad	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 10:34
6	116	(((endpoint adj1 detect$) and polishing or planarization) and pad) and electrolyte	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 10:40
7	626	(endpoint adj1 detect$) and (planarization or polishing)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 10:41
8	17	((endpoint adj1 detect$) and (planarization or polishing)) and electrolyte	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 11:07
9	43309	204/$.ccls.	USPAT	2003/10/01 11:07
10	77	204/$.ccls. and (endpoint adj1 detect$)	USPAT	2003/10/01 11:08
1	1502	endpoint adj1 detect$	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 11:55
11	1	("5096550").PN.	USPAT	2003/10/01 11:54
12	1	("5081796").PN.	USPAT	2003/10/01 11:54
13	34	(endpoint adj1 detect$) and electrolyte	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 11:56
14	11	((endpoint adj1 detect$) and electrolyte) and pad	USPAT; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 12:28
15	3	electrochemical adj1 mechanical adj1 polishing	USPAT	2003/10/01 12:29
16	35	(electrochemical adj1 mechanical adj1 polishing) or ecmp	USPAT	2003/10/01 12:34
17	1024	204/224m	USPAT	2003/10/01 12:48
18	48	204/224m and pad	USPAT	2003/10/01 12:48

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